

EL792822741

#74

Pre Amended
A

Revised
2/19/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No.09/468,247
 Priority Filing Date12/20/99
 Inventor.....Perino et al.
 Applicant.....Rambus, Inc.
 Priority Group Art Unit2833
 Priority ExaminerPaumen
 Attorney's Docket No.RB1-035USC3
 Title: Chip Socket Assembly and Chip File Assembly for Semiconductor Chips

PRELIMINARY AMENDMENT

To: Commissioner of Patents and Trademarks,
 Washington, D.C. 20231

From: Daniel L. Hayes (Tel. 509-324-9256; Fax 509-323-8979)
 Customer No. 29501



29150

PATENT & TRADEMARK OFFICE

AMENDMENTS

In the Specification:

On page 2, prior to the heading "FIELD OF THE INVENTION", please
 insert the following:

--RELATED APPLICATIONS

This is a continuation of U.S. Patent Application Serial No. 09/468,247,
 filed December 20, 1999, which is now U.S. Patent No. ---

In the Claims:

Please cancel ☒ claims 1-67.

Please add the following new claims 68-90.